



Objective:

This report shows a possible preparation method for a glass sample. The workpiece is first cut with the Qcut 200 A and then mounted with Qprep UV-50 or KEM 30. The sample is finally ground and polished on the Qpol 300 or 250 A1 Eco.

Cutting

Cutting					
Device	Cut-off disc	Anti-c	orrosion coolant	Clamping tool	
Qcut 200 A	Diamond cut-off wheel 92002406	QATM Standard, 95014281		- Easy Clamping Base S Z2236030 - Qtool 40 S Z2270201	
Cutting method					
Automatic vertical cutting method (with Y-Axis)					
Parameters					
Feed speed	Pulse parameter		Cut-off disc rotational speed		
0,08 mm/s	Without pulse		3000 RPM		
Notes					
- protect the glass with paper tape against breaking during cutting (picture 2)					





Figure 1: Overview of the cutting machine "Qcut 200 A".

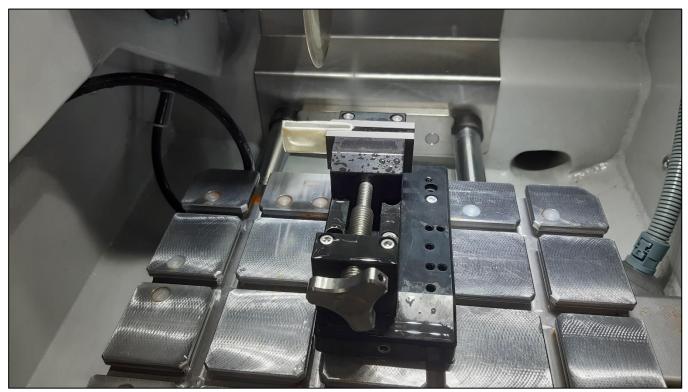


Figure 2: Overview of the clamping tool – glass sample is protected with paper tape.



UV mounting

Mou	inting				
Device	Consumable	Curing time	Mold	Additional equip.	
QMOUNT UV 50		1-1,5 Minutes	PP or PE, ø 40 mm	-	
Notes					
 we recommend doing the mounting in a way that enables you to grind and polish the glass sample from both sides 					

Cold mounting (alternative)

Mounting				
Consumable	Mixing ratio	Curing time	Mold	Additional equip.
KEM 30	Volume / Weight 2:1	Max. 15 Minutes	PP or PE, ø 40 mm	- dosing spoon - mixing cup - mixing stick
Notes				
 we recommend doing the mounting in a way that enables you to grind and polish the glass sample from both sides 				



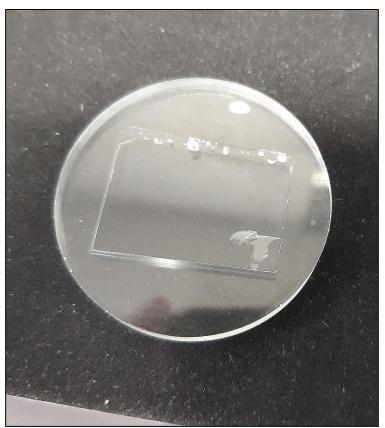


Figure 3: Overview of prepared glass sample - cold mounting with KEM 50 UV.

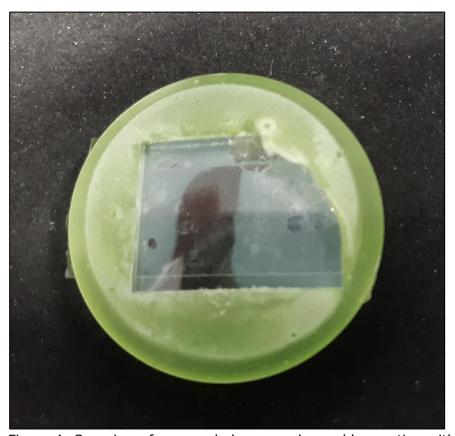


Figure 4: Overview of prepared glass sample – cold mounting with KEM 30.





Grinding/Polishing

Device	Sample holder	Pressure mode				
Qpol 300 A1 Eco+/ Qpol 250 A1 Eco	Z5446025/ Z5445025	Single				
Step	MEDIUM	₹.	RPM	*	↓F _N	min
Planar grinding	SiC-Paper, self-adhesive P320	H₂O	125	75 ▶▶	10	Till sample is plane (0:45)
Grinding	VEGA 10 μm	H ₂ O	125	75 ▶▶	15	3:00
Grinding	Polaris H 3 µm	H ₂ O	150	100	20	7:00
Polishing	GAMMA or DELTA	Dia Complete Poly, 3 μm	150	100 ▶▶	30	14:00
Natas	CH - rpm for	sample holder				

Notes

- SH = rpm for sample holder
- WP = rpm for working plate
- pre-dosing time for polishing with 3 $\mu m = 3 \text{ s}$
- dosing interval and dosing time for 3 μ m = every 45 s for 2 s
- recommendation: before starting to polish the opposide glass surface ${f protect}$ the finished glass surface with tape





Figure 5: Glass surface after polishing with GAMMA and 3 μm – edge area with darkfield -100 x.



Figure 6: Glass surface after polishing with GAMMA and 3 μm – edge area with darkfield - 100 x.







Figure 7: Glass surface after polishing with GAMMA and 3 μm – core area with darkfield - 100 x.

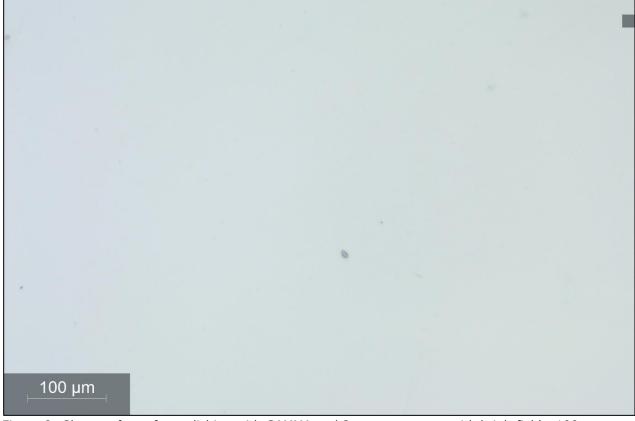


Figure 8: Glass surface after polishing with GAMMA and 3 μm – core area with brightfield - 100 x.

